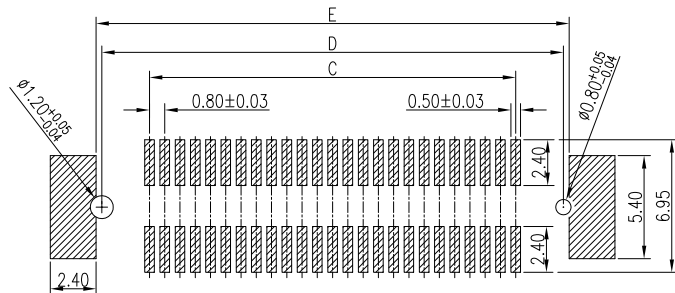
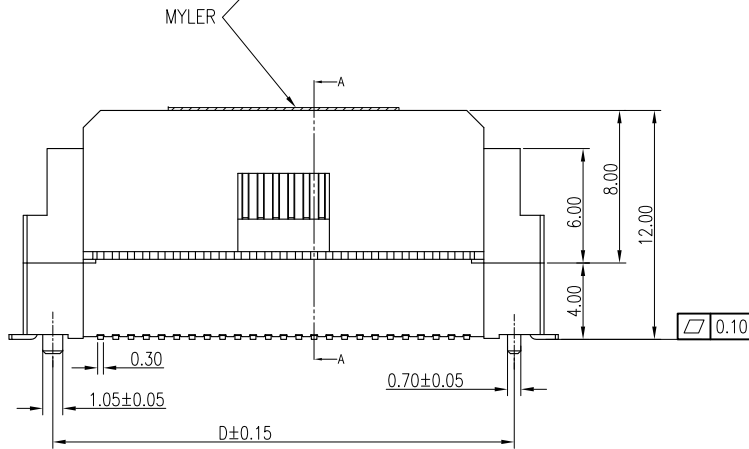
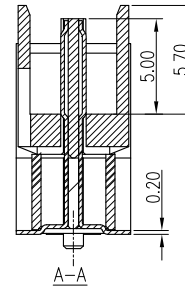
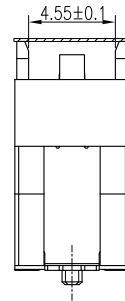
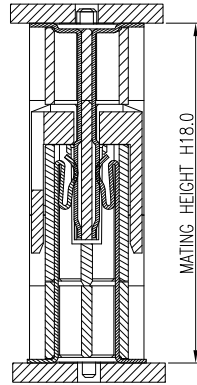
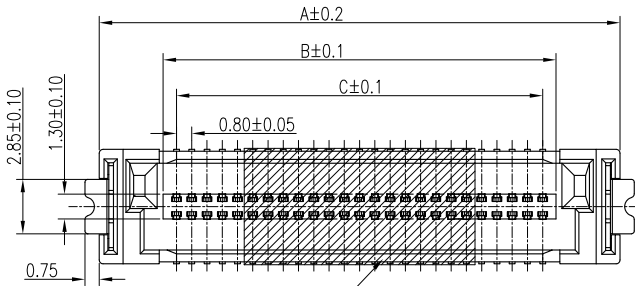


HSF Compliant



RECOMMENDED PCB LAYOUT (TOP SIDE)
TOLERANCES UNLESS OTHERWISE
SPEC. ±0.05

料号备注

QW2 8 M XX 01 M XX R XX X X

20=20PIN
30=30PIN
40=40PIN
50=50PIN
60=60PIN
80=80PIN
100=100PIN
120=120PIN
160=160PIN

12=半金镀金
13=半金镀金
14=半金镀金
15=半金镀金
16=半金镀金

00=黑色
01=白色

R=ROHS2.0标准 P=环保2组

NOTES:

MATERIAL:

1.HOUSING:THERMO-PLASTIC. UL 94V-0 NATURE

2.CONTACT:PHOSPHOR BRONZE

CONTACT:SEE ORDER INF ORMATION; SOLDER:GOLD FLASH

UNDERPLATING:50~120u" NICKEL OVERALL

3.SOLDER TAB:PHOSPHOR BRONZE

TOTAL:80~150u" TIN PLATED OVERAL

UNDERPLATING:50~120u" NICKEL OVERALL

ELECTRICAL:

1.CURRENT RATING:0.5A 50V AC/DC

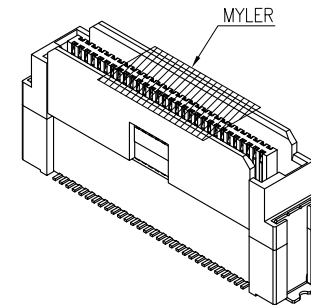
2.WITHSTANDING VOLTAGE:250V AC for 1 min

3.CONTACT RESISTANCE:65mΩ MAX

4.INSULATION RESISTANCE:100MΩ MIN

ENVIRONMENTAL:

1. OPERATING TEMPERATURE:-55°C TO +125°C.



No.of Pins	Dimension				
	A	B	C	D	E
20	15.30	8.60	7.20	12.2	12.80
30	19.30	12.60	12.20	16.20	16.80
40	23.30	16.60	15.20	20.20	20.80
50	27.30	20.60	19.20	24.20	24.80
60	31.30	24.60	23.20	28.20	28.80
80	39.30	32.60	31.20	36.20	36.80
100	47.30	40.60	39.20	44.20	44.80
120	55.30	48.60	47.20	52.20	52.80
160	71.30	64.60	63.20	68.20	68.80



东莞市兴科杰鑫电子有限公司

Dong Guan XingKeJieXin Electronics Co.,Ltd

UNLESS OTHERWISE SPECIFIED TOLERANCES		APPROVAL		日期	品名规格
.X	+/-	制图	Erica	24.05.21	BOARD TO BOARD MALE D型 180度SMT PH0.8 H12.0 合高H18.0
.XX	+/-	审核	Linson	24.05.21	
.XXX	+/-	核准	Rambo	24.05.21	
FRACTIONS +/-		文件位置		料号	SEE TABLE
ANGLES +/-		ANGLE OF PROJECTION		字张	
DIMENSIONS				A4	工程图号: DWG-BTOBM-001
(METRIC)	(MM)			比例	1 : 1
				状态码	A
				页数	1 OF 1
				版本	A0